## XR819MQ Module Datasheet

IEEE 802.11 b/g/n WLAN

Version 1.1

June.26, 2017

### **Revision History**

Revision	Date	Notes		
1.0	2017/5/26	Initial release version		
1.1	2017/6/27	Change the Temperature range		

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#### 1. Introduction

XR819MQ product is designed base on XR819 chipset .It is a fully integrated 2.4G WLAN module to support 802.11 b/g/n. It is optimized for mobile applications such as PDAs and portable media players. The low power consumption and intelligent host off loading of beacon as well as the packet processing ensure better battery life. High sensitivity and transmitting power ensure long distance and robust connection. Highest level of integration allows very compact and cost effective reference designs delivering fast time-to-market for new WLAN enabled products.

#### 2. Features

- Compatible with IEEE 802.11 b/g/n standard
- On-chip auto calibrations
- Intelligent adaptive power control for
  - Saving power consumption
  - Tolerating VSWR variation to maintain EVM performance
- WLAN solution with fully integrated
  - High power PA
  - TR switch
  - Internal impedance matching network
  - OFDM/CCK PHY processor
  - SDIO 2.0 host interface
- Support for 6 Mbps to 65 Mbps OFDM
  - -11 Mbps and 5.5 Mbps CCK and legacy
  - 2 Mbps and 1 Mbps DSSS data rates
- WiFi Direct support with concurrent operation
- Supports MAC enhancements including
  - 802.11d Regulatory domain operation
  - 802.11e QoS including WMM
  - 802.11h Transmit power control dynamic and frequency selection
  - 802.11i Security including WPA2 and WAPI compliance
  - 802.11r Roaming
  - 802.11w Management frame protection

## 3. Applications

- Tablet PC applications
- Portable media player(PMP) applications
- Portable gaming device(PGD) applications
- Smart internet TV box applications
- Internet of Thing (IOT)

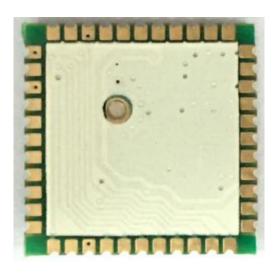
# 4. General Specification

Item	Description		
Product Name	XR819MQ		
Major Chipset	XR819		
Host Interface	SDIO 2.0		
Standard	IEEE 802.11b,IEEE 802.11g,IEEE 802.11n		
Frequency Range	2.4GHz — 2.484GHz		
	802.11b:CCK,DQPSK,DBPSK;		
Modulation Type	802.11g:64-QAM,16-QAM,QPSK,BPSK;		
	802.11n:64-QAM,16-QAM,QPSK,BPSK;		
Data Transfer Rate	1,2,5.5,6,6.5,9,11,12,13,18,19.5,24,26,36,39,48,52,54,		
Data Hallstel Nate	58.5 and maximum of 65Mbps		
	802.11b:(1M: -96dBm@8%, 11M: -89dBm@8%);		
Sensitivity @PER	802.11g:(6M: -90dBm@10%, 54M: -73dBm@10%);		
	802.11n:(MCS0: -90dBm@10%, MCS7: -70dBm@10%);		
RF Power	16±2dBm@11b,15±2dBm@11g ,14±2dBm@11n		
Dimension(L*W*H)	12 x12x 0.8mm (LxWxH) ;Tolerance: +-0.1mm		
Clock source	24MHz		
Working Temperature	-20°C ~ +85°C		
Storage temperature	-40°C ~ +85°C		

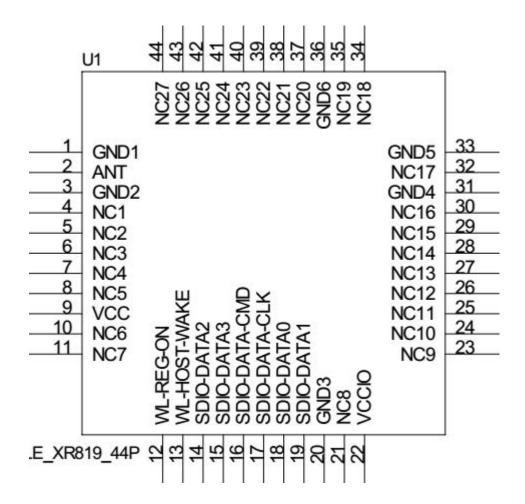
# 5. Product appearance

TOP BOTTOM





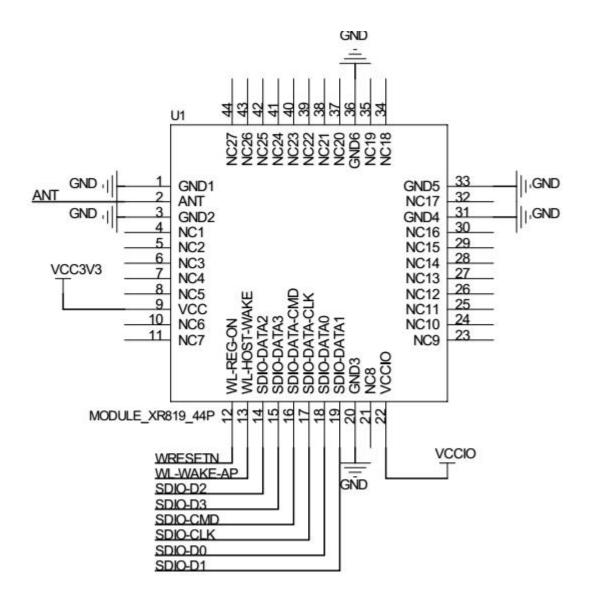
#### 6. Pin List



Pin	Name	Description		
1	GND1	GND		
2	ANT	RF input/output port		
3	GND2	GND		
4	NC1	NC		
5	NC2	NC		
6	NC3	NC		
7	NC4	NC		
8	NC5	NC		
9	VCC	3.3V Supply for module		
10	NC6	NC		
11	NC7	NC		
12	WL-REG-ON	Reset, active low		
13	WL-HOST-WAKE	WLAN wake-up HOST		
14	SDIO-DOTA2	SDIO data2		

15	SDIO-DOTA3	SDIO data3		
16	SDIO-DOTA-CMD	SDIO command		
17	SDIO-DOTA-CLK	SDIO clock		
18	SDIO-DOTA0	SDIO data0		
19	SDIO-DOTA1	SDIO data1		
20	GND3	GND		
21	NC8	NC		
22	VDDIO	I/O voltage Supply input		
23	NC9	NC		
24	NC10	NC		
25	NC11	NC		
26	NC12	NC		
27	NC13	NC		
28	NC14	NC		
29	NC15	NC		
30	NC16	NC		
31	GND4	GND		
32	NC17	NC		
33	GND5	GND		
34	NC18	NC		
35	NC19	NC		
36	GND6	GND		
37	NC20	NC		
38	NC21	NC		
39	NC22	NC		
40	NC23	NC		
41	NC24	NC		
42	NC25	NC		
43	NC26	NC		
44	NC27	NC		

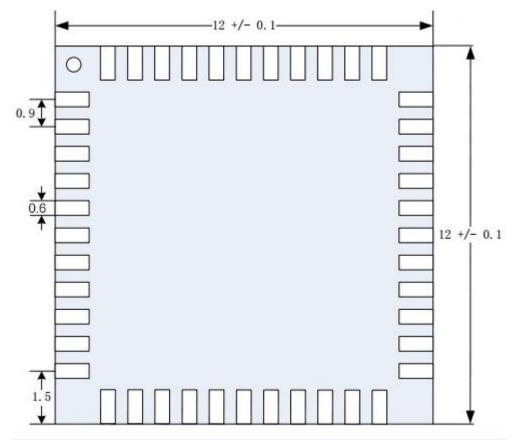
### 7. Reference design circuit



#### design note:

- 1. The impedance of ANT line must be 50 ohm.
- 2. The voltage supplied through the pin VCC should between 3.0V-3.6V.
- 3. SDIO line cannot be longer than 150mm.
- 4. VCCIO voltage to be consistent with the HOST I/O voltage between 2.5V-3.6V

# 8. Mechanical Specification



Unit : ( mm )

### 9. DC Characteristics

Symbol	Parameter	Min	Тур	Max	Unit
VCC	3.3V Supply for module	3.0	3.3	3.6	V
VCCIO	I/O voltage Supply input	2.5	3.0	3.6	V